TE Internal #: 2357518-1 zSFP+ Stacked Belly to Belly, Cage Assembly with Integrated

Connector, 14.25mm [.56in] Centerline, Signal

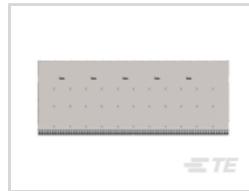
View on TE.com >



### Connectors > Pluggable IO Connectors & Cages











Form Factor: **zSFP+ Stacked Belly to Belly** 

Pluggable I/O Product Type: Cage Assembly with Integrated Connector

Centerline (Pitch): 14.25 mm [ .56 in ]

Sealable: No

Circuit Application: Signal

### **Features**

### **Product Type Features**

Cage Type	Stacked
Form Factor	zSFP+ Stacked Belly to Belly
Pluggable I/O Product Type	Cage Assembly with Integrated Connector
Sealable	No
Configuration Features	
Number of Positions	480
Number of Ports	24
Port Matrix Configuration	2 x 12
Electrical Characteristics	
Data Rate (Max)	28 Gb/s

### **Contact Features**

Contact Current Rating (Max)	.5 A
Contact Underplating Material	Nickel
Contact Mating Area Plating Material	Gold (Au)
Tail Plating Material	Tin



PCB Contact Termination Area Plating Material	Tin	
Contact Mating Area Plating Material Thickness	.76 μm[30 μin]	
Termination Features		
Termination Method to PCB	Through Hole - Press-Fit	
Termination Post & Tail Length	1.8 mm[.071 in]	
Housing Features		
Cage Material	Stainless Steel	
Centerline (Pitch)	14.25 mm[.56 in]	
Dimensions		
PCB Thickness (Recommended)	1.5 mm[.059 in]	
Usage Conditions		
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]	
Operation/Application		
Pluggable I/O Applications	SFP+ Stacked Belly-to-Belly	
Heat Sink Compatible	No	
Circuit Application	Signal	
Industry Standards		
UL Flammability Rating	UL 94V-0	
Packaging Features		
Packaging Method	Box & Tray	
Other		
Included Lightpipe	No	
EMI Containment Feature Type	Internal/External EMI Springs	

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JUNE 2022 (224)



$\square$	n 0 +	aantain	REACH	CV/IIC
DOES	$\Gamma(C)$	contain	KFAU.H	$\Sigma V \square U$

Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC
	Free

Solder Process Capability

Not applicable for solder process capability

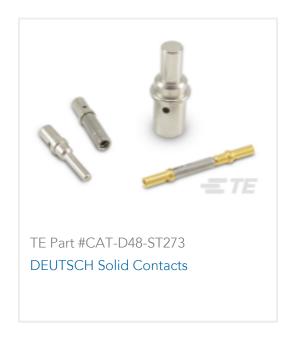
#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## Compatible Parts



# **Customers Also Bought**

















### **Documents**

#### **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_2357518-1\_B.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2357518-1\_B.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2357518-1\_B.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

### **Product Specifications**

**Application Specification** 

English